MCR8DCM

MCR8DCN

Motorola Preferred Devices

SCRs 8.0 AMPERES RMS

Silicon Controlled Rectifiers Reverse Blocking Thyristors

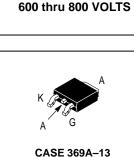
Designed for high volume, low cost, industrial and consumer applications such as motor control; process control; temperature, light and speed control.

- Small Size
- Passivated Die for Reliability and Uniformity
- Low Level Triggering and Holding Characteristics
- Available in Two Package Styles Surface Mount Lead Form — Case 369A Miniature Plastic Package — Straight Leads — Case 369

ORDERING INFORMATION

- To Obtain "DPAK" in Surface Mount Leadform (Case 369A) Shipped in Sleeves — No Suffix, i.e. MCR8DCN Shipped in 16 mm Tape and Reel — Add "T4" Suffix to Device Number, i.e. MCR8DCNT4
- To Obtain "DPAK" in Straight Lead Version (Case 369) Shipped in Sleeves Add "–1" Suffix to Device Number, i.e. MCR8DCN–1

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted)



STYLE 4

| Rating | | Symbol | Value | Unit |
|---|--------------------|---------------------|------------|--------------------|
| Peak Repetitive Off–State Voltage (1) Peak Repetitive Reverse Voltage (T _J = -40 to 125°C) | MCR8DCM MCR8DCN | VDRM VRRM | 600 800 | Volts |
| On–State RMS Current (All Conduction Angles; T _C = 105°C) | | ^I T(RMS) | 8.0 | Amps |
| Average On–State Current (All Conduction Angles; $T_C = 105^{\circ}C$) | | I _{T(AV)} | 5.1 | |
| Peak Non–Repetitive Surge Current (One Half Cycle, 60 Hz, T _J = 125°C) | | ITSM | 80 | |
| Circuit Fusing Consideration (t = 8.3 msec) | | l ² t | 26 | A ² sec |
| Peak Gate Power (Pulse Width \leq 10 μ sec, T _C = 105°C) | | PGM | 5.0 | Watts |
| Average Gate Power (t = 8.3 msec, T _C = 105°C) | | PG(AV) | 0.5 | |
| Peak Gate Current (Pulse Width \leq 10 µsec, T _C = 105°C) | | I _{GM} | 2.0 | Amps |
| Operating Junction Temperature Range | | ТJ | -40 to 125 | °C |
| Storage Temperature Range | | T _{stg} | -40 to 150 | |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|--|---|-----------------|------|
| Thermal Resistance — Junction to Case — Junction to Ambient — Junction to Ambient ⁽²⁾ | R _θ JC R _θ JA R _θ JA | 2.2 88 80 | °C/W |
| Maximum Lead Temperature for Soldering Purposes (3) | тլ | 260 | °C |

(1) V_{DRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the device are exceeded.

(2) Surface mounted on minimum recommended pad size.

(3) 1/8" from case for 10 seconds.

Preferred devices are Motorola recommended choices for future use and best overall value.



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ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

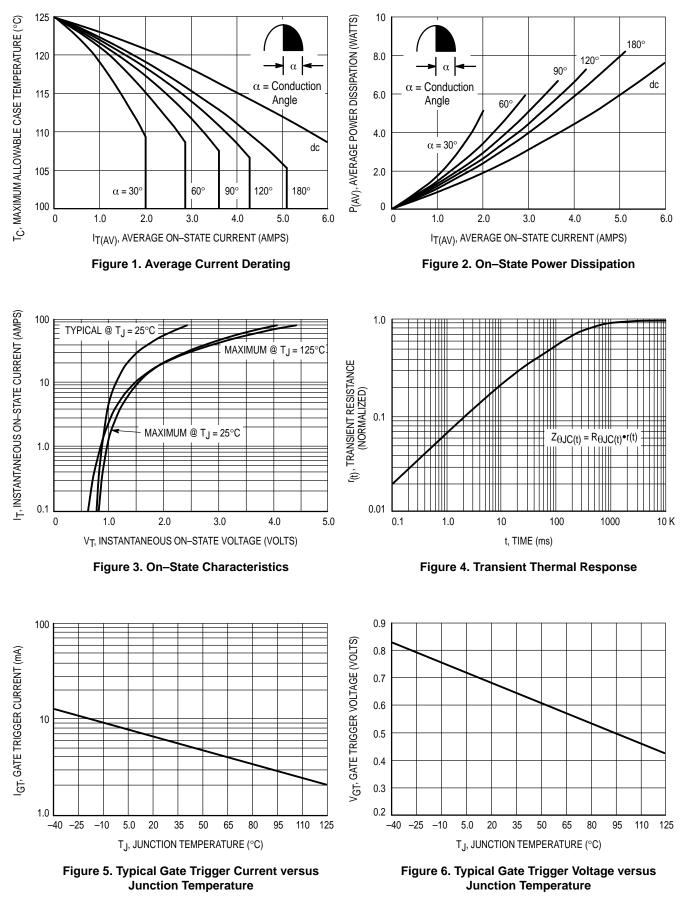
| Characteristics | Symbol | Min | Тур | Max | Unit |
|--|-----------------|-----------------|----------------|-----------------|-------|
| Peak Forward Blocking CurrentPeak Reverse Blocking Current $(V_{AK} = Rated V_{DRM} \text{ or } V_{RRM}, Gate Open)$ $T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$ | IDRM IRRM | | | 0.01 5.0 | mA |
| Peak On–State Voltage (1) (I _{TM} = 16 A) | VTM | _ | 1.4 | 1.8 | Volts |
| Gate Trigger Current (Continuous dc) $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega, \text{ T}_J = 25^{\circ}\text{C})$ $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega, \text{ T}_J = -40^{\circ}\text{C})$ | lgt | 2.0 | 7.0 — | 15 30 | mA |
| Gate Trigger Voltage (Continuous dc) $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega, \text{ T}_J = 25^{\circ}\text{C})$ $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega, \text{ T}_J = -40^{\circ}\text{C})$ $(V_D = 12 \text{ V}, \text{ R}_L = 100 \Omega, \text{ T}_J = 125^{\circ}\text{C})$ | V _{GT} | 0.5 — 0.2 | 0.65 — — | 1.0 2.0 — | Volts |
| Holding Current ($V_D = 12 V$, $I_T = 200 mA$, $T_J = 25^{\circ}C$) ($V_D = 12 V$, $I_T = 200 mA$, $T_J = -40^{\circ}C$) | ΙΗ | 4.0 | 22 — | 30 60 | mA |
| Latching Current ($V_D = 12 V$, $I_G = 15 mA$, $T_J = 25^{\circ}C$) ($V_D = 12 V$, $I_G = 30 mA$, $T_J = -40^{\circ}C$) | ιL | 4.0 | 22 — | 30 60 | mA |

DYNAMIC CHARACTERISTICS

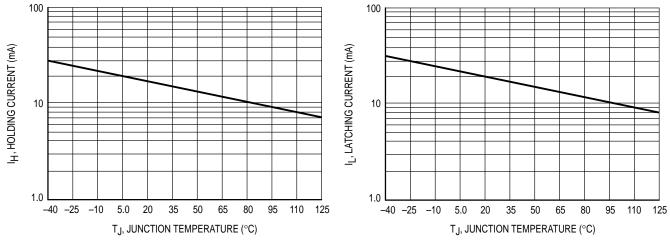
| Characteristics | Symbol | Min | Тур | Max | Unit |
|--|--------|-----|-----|-----|------|
| Critical Rate of Rise of Off-State Voltage | dv/dt | | | | V/μs |
| (V _D = Rated V _{DRM} , Exponential Waveform, Gate Open, T_J = 125°C) | | 50 | 200 | — | |

(1) Pulse Test; Pulse Width \leq 2.0 msec, Duty Cycle \leq 2%.

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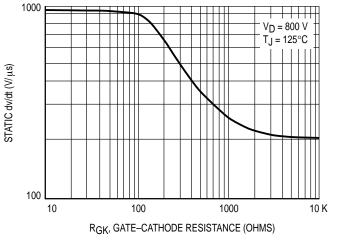
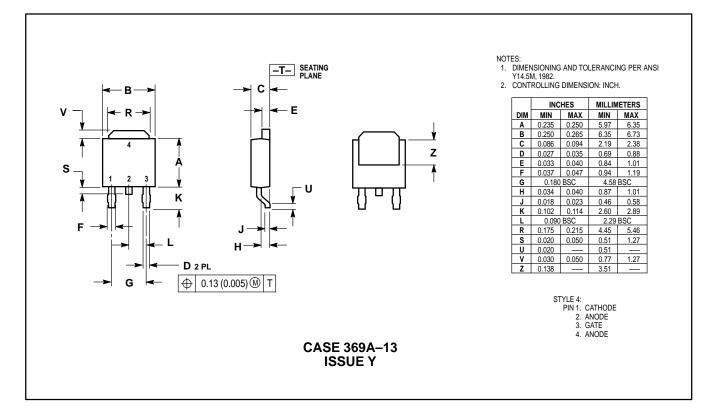


Figure 9. Exponential Static dv/dt versus Gate–Cathode Resistance

PACKAGE DIMENSIONS



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